

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	ROBERT C. HAYZELDEN	11/13/2019
RECEIVING PARTY DATA		
Name:	ABBOTT CARDIOVASCULAR SYSTEMS INC.	
Street Address:	3200 LAKESIDE DRIVE	
City:	SANTA CLARA	
State/Country:	CALIFORNIA	
Postal Code:	95054	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	16671057
CORRESPONDENCE DATA		
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
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Address Line 4:	LOS ANGELES, CALIFORNIA 90045	
ATTORNEY DOCKET NUMBER:	ACS-98921	
NAME OF SUBMITTER:	JOHN S. NAGY	
SIGNATURE:	/john s. nagy/	
DATE SIGNED:	11/14/2019	
Total Attachments: 2		
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ASSIGNMENT

This Assignment made by Robert C. Hayzelden, residing in California (Assignor), to Abbott Cardiovascular Systems Inc., a California corporation, Assignee, having a place of business at 3200 Lakeside Drive, Santa Clara, California 95054.

WHEREAS, Assignor has invented a new and useful MOLD FOR FORMING SOLDER DISTAL TIP FOR GUIDEWIRE for which an application for United States Letters Patent was filed under Serial No.: 16/671,057 on October 31, 2019; and

WHEREAS, Assignor believes himself to be the original and first inventor of the invention disclosed and claimed in said application for Letters Patent; and

WHEREAS, Assignee desires to acquire by formal, recordable assignment the entire right, title and interest in and to said invention, said application, and any Letters Patent that may be granted for said invention in the United States and throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, Assignor hereby sells, assigns and transfers to Assignee, the entire right, title and interest in and to said invention, said application, and any Letters Patent that may be granted for said invention in the United States and throughout the world, including the right to file foreign applications directly in the name of the Assignee and to claim for any such foreign applications any priority rights to which such applications are entitled under international conventions, treaties or otherwise.

Further, Assignor agrees that, upon request and without further compensation, but at no expense to Assignor, he and his legal representative(s) and assigns will do all lawful acts, including the execution of papers and the giving of testimony, that may be necessary or desirable for obtaining, sustaining, reissuing or enforcing Letters Patent in the United States and throughout the world for said invention, and for perfecting, recording or maintaining the title of Assignee, its successors and assigns, to said invention, said application, and any Letters Patent granted for said invention in the United States and throughout the world.

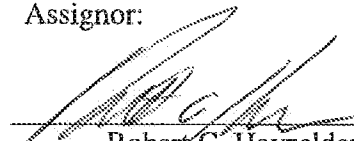
Assignor represents and warrants that he has not granted and will not grant to others any rights inconsistent with the rights granted herein.

Assignor authorize and requests the Commissioner of Patents and Trademarks of the United States and of all foreign countries to issue any Letters Patent granted for said invention, whether on said application or on any subsequently filed division, continuation, continuation-in-part or reissue application, to Assignee, its successors and assigns, as the assignee of the entire interest in said invention.

IN WITNESS WHEREOF, Assignor has executed this Assignment on the date written herein below.

Date: November 13, 2019

Assignor:


Robert C. Hayzelden